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**Herbert**

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[54] **3- AND 4-TERMINAL CAPACITORS WITH  
"FARADAY-SHIELDED" CONNECTIONS**

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5,544,002 8/1996 Iwaya et al. .

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[21] Appl. No.: **08/876,299**

[22] Filed: **Jun. 16, 1997**

[57] **ABSTRACT**

**Related U.S. Application Data**

[ 60] Provisional application No. 60/621,121, Jun. 27, 1996.

[51] **Int. Cl.<sup>6</sup>** ..... **H01G 4/228; H01G 4/232**

[52] **U.S. Cl.** ..... **361/306.1; 361/307; 361/308.3;**  
361/309; 361/306.3

[58] **Field of Search** ..... 361/301.2, 302,  
361/306.1–306.3, 307, 308.1–308.3, 309–310;  
333/182; 174/143

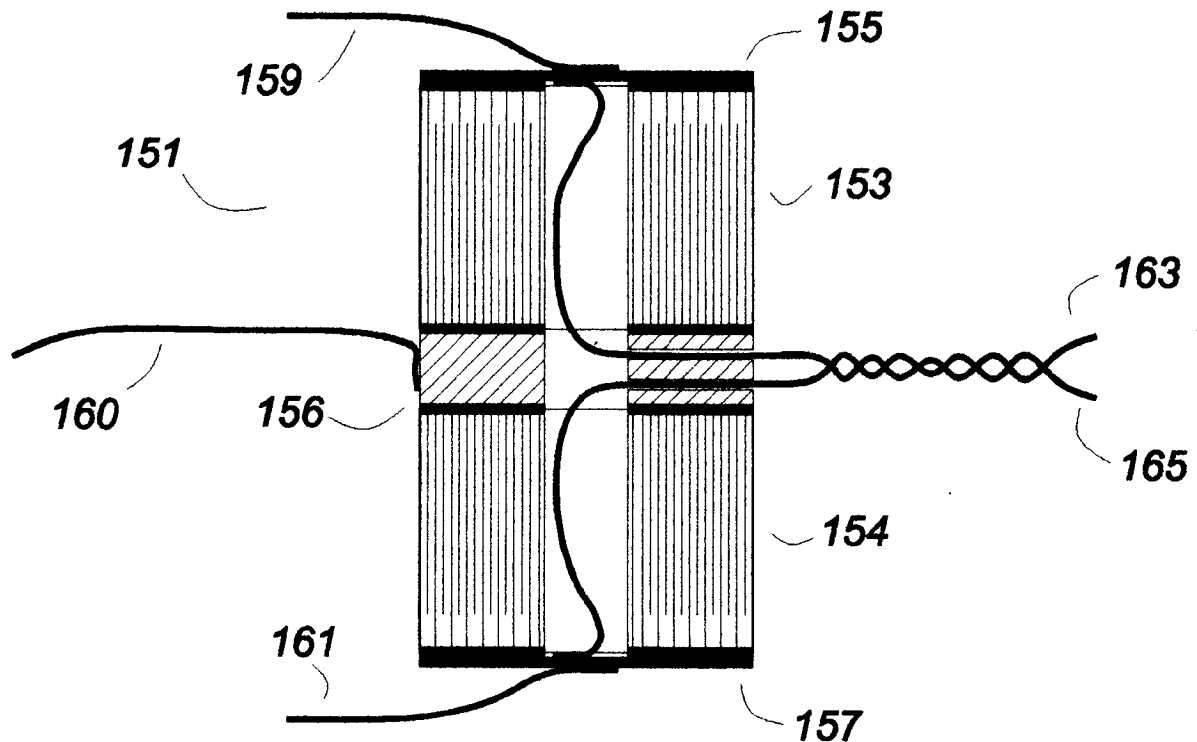
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A tubular capacitor made of metallized film may be drilled through to its hollow center during its manufacture, and any resulting short circuits may be cleared by the application of electrical energy. Third and fourth leads may be attached to end caps on their inside surface, and the leads can be brought out through the through hole. The end caps may have a thickness that is large compared to the penetration depth at a frequency of interest. The capacitor may be used as a four terminal capacitor, for instance, in a switched mode power supply filter, and it will have superior rejection of high frequency AC noise. The two internally connected leads may also be used as a low inductance alternative connection for a two terminal capacitor.

**13 Claims, 7 Drawing Sheets**



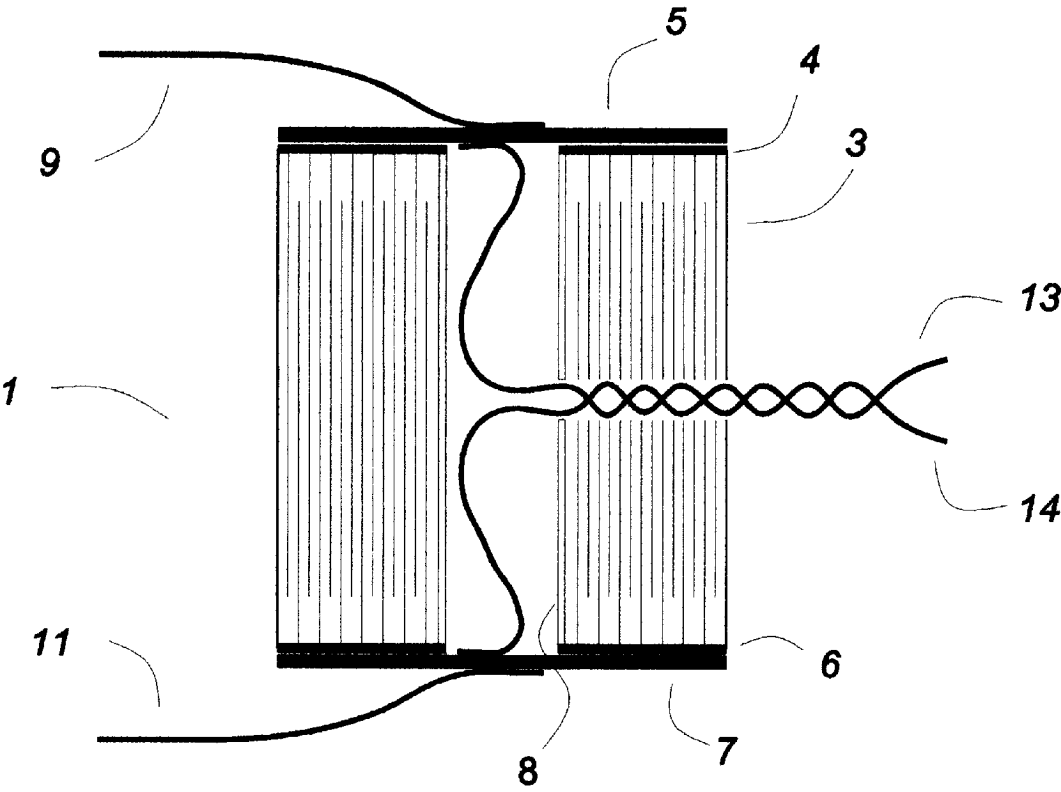


Fig. 1

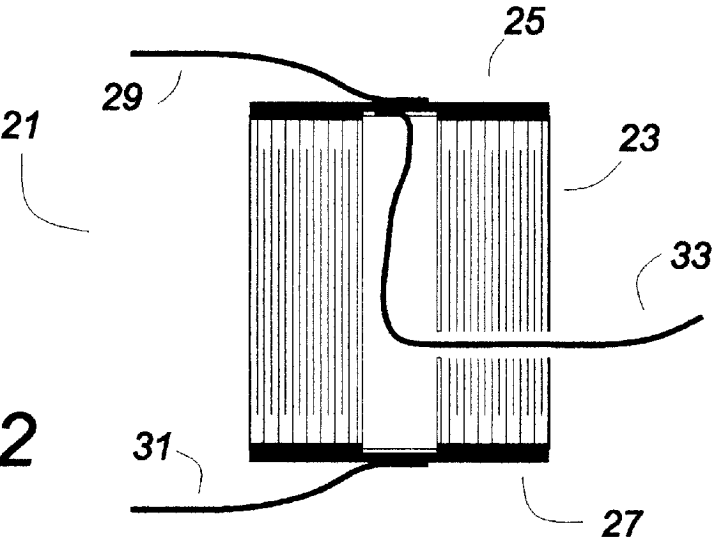


Fig. 2

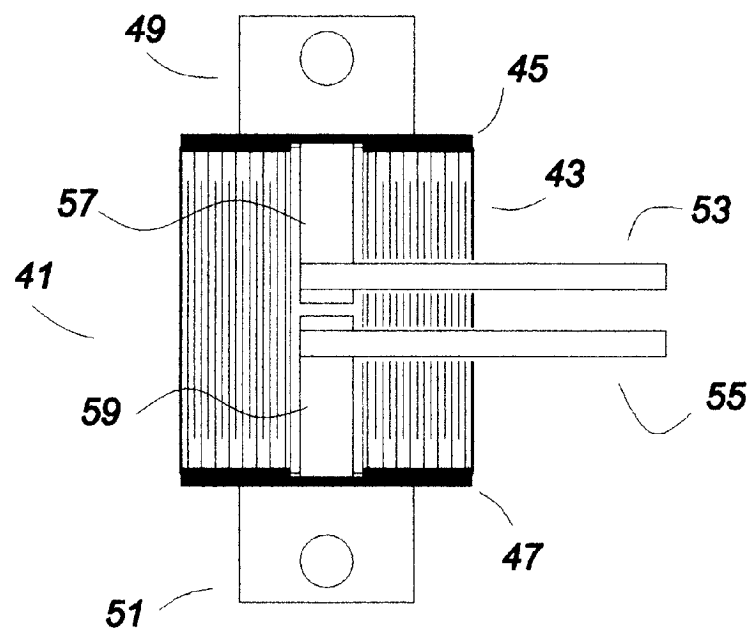


Fig.3

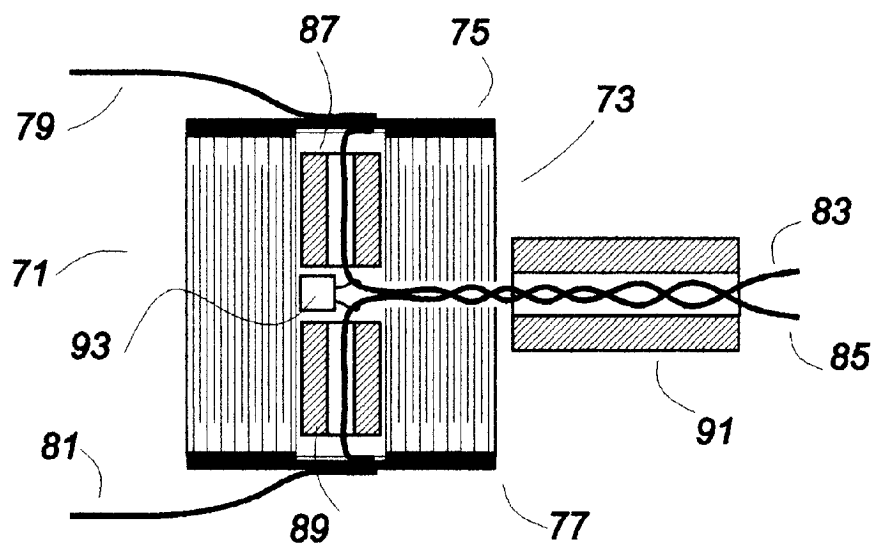


Fig.4

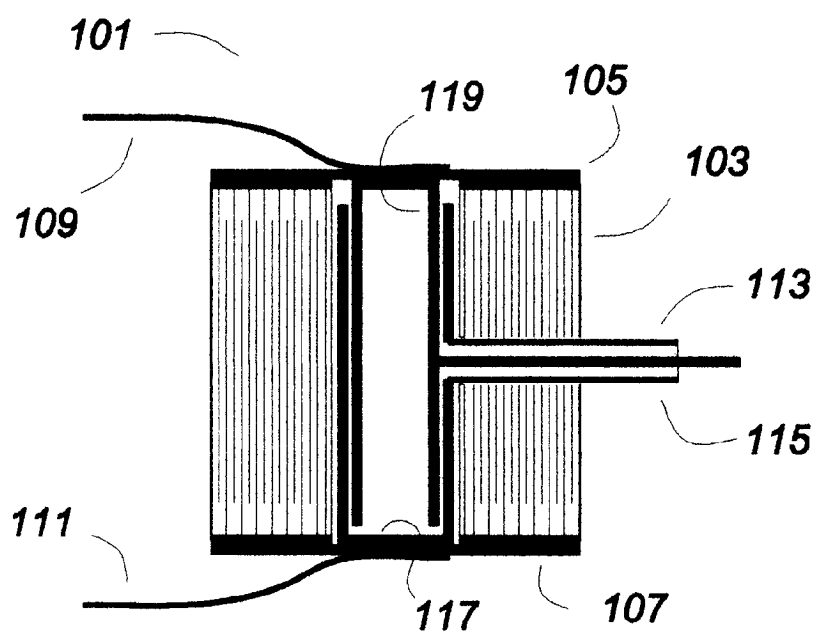


Fig. 5

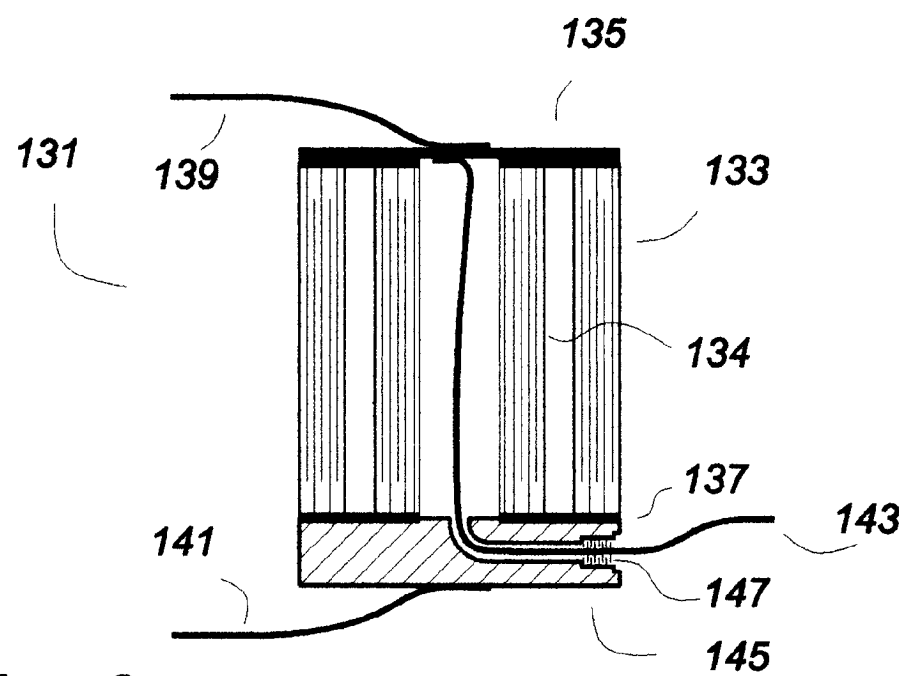
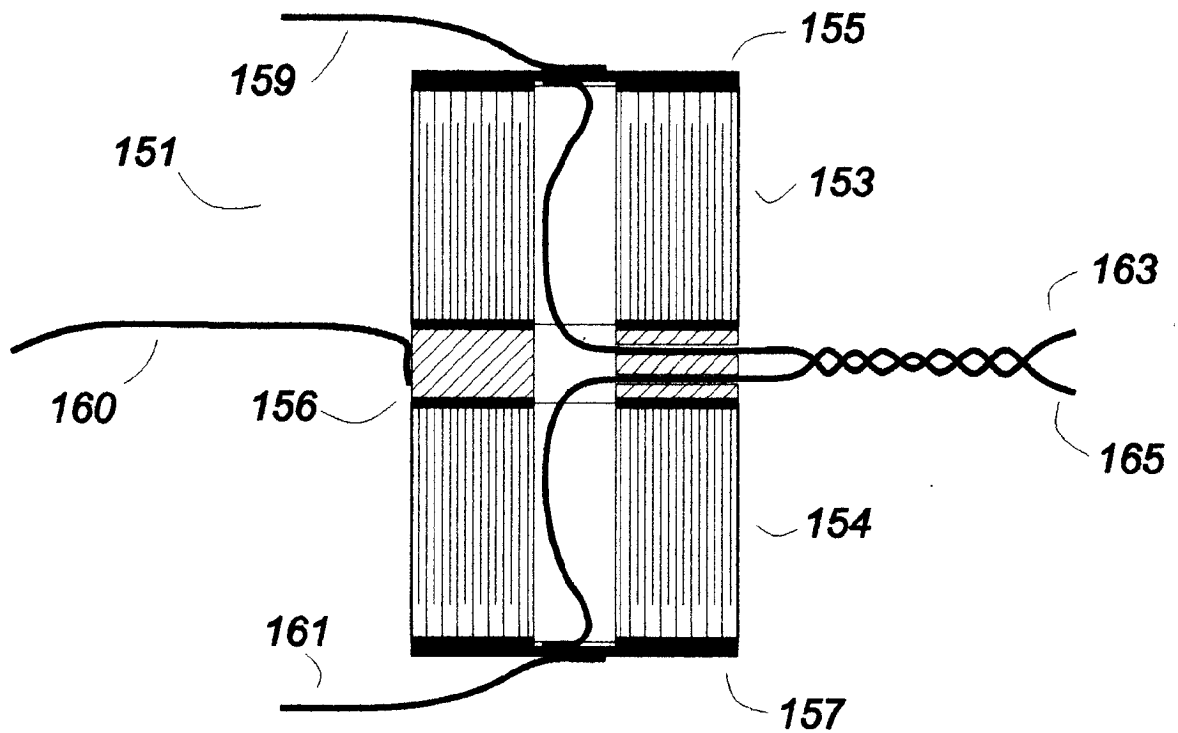
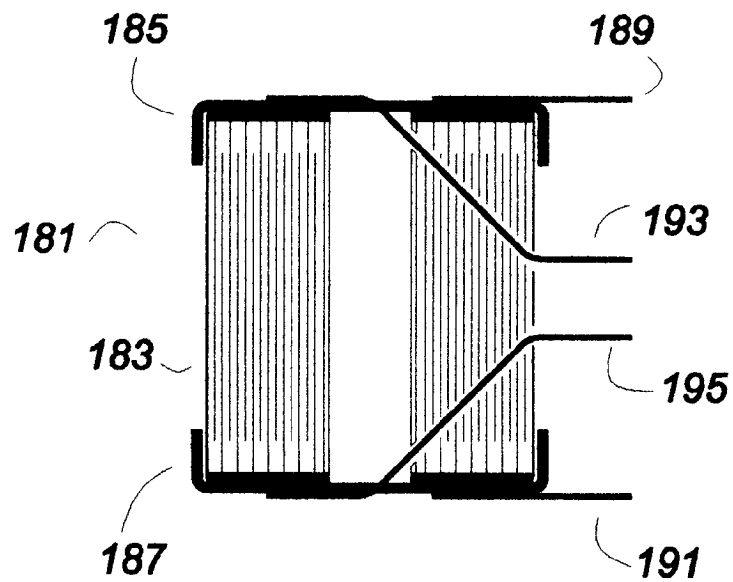


Fig. 6



**Fig. 7**



**Fig. 8**

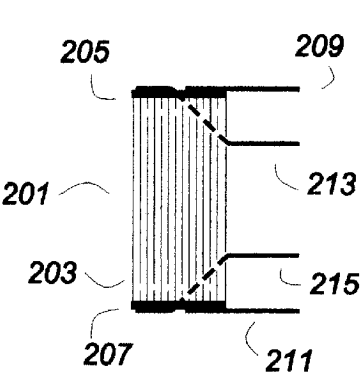


Fig. 9

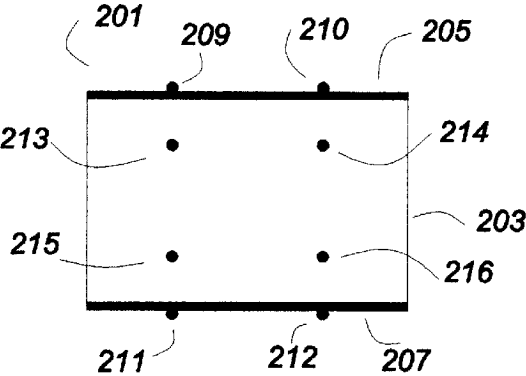


Fig. 10

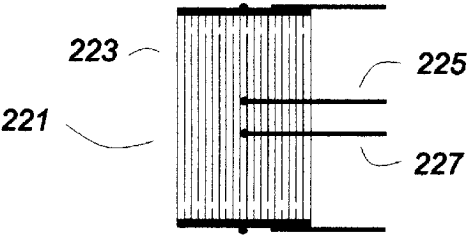


Fig. 11

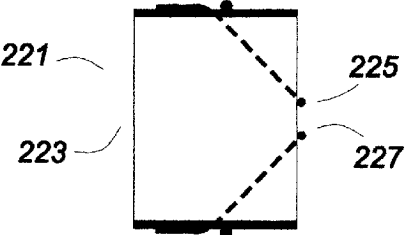


Fig. 12

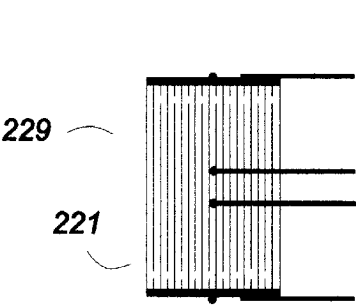


Fig. 13

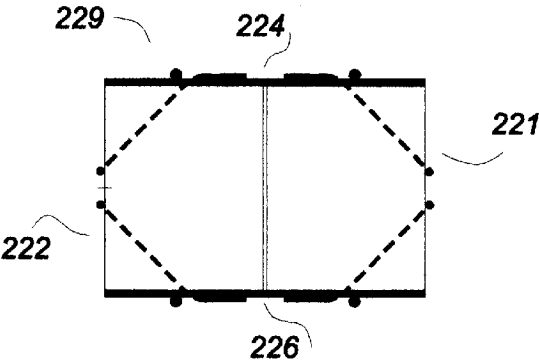


Fig. 14

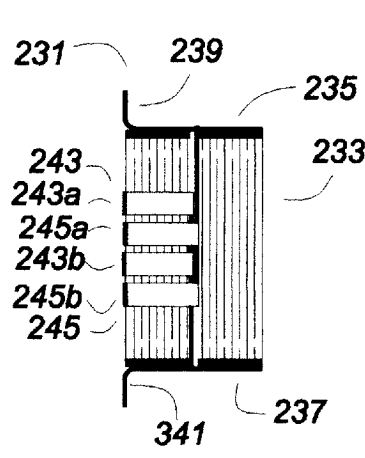


Fig. 15

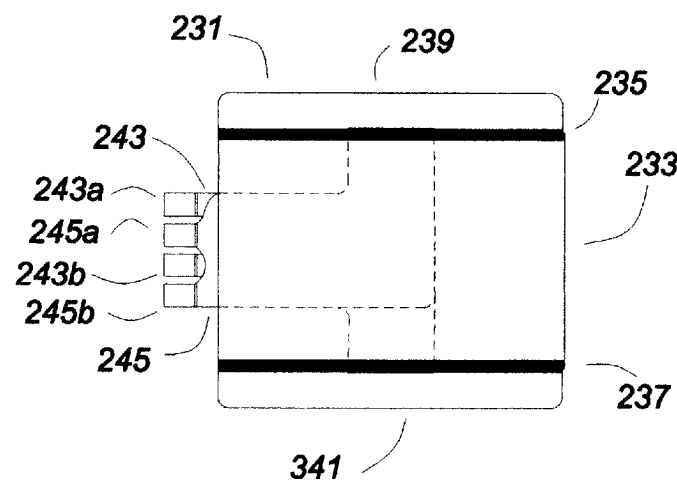


Fig. 16

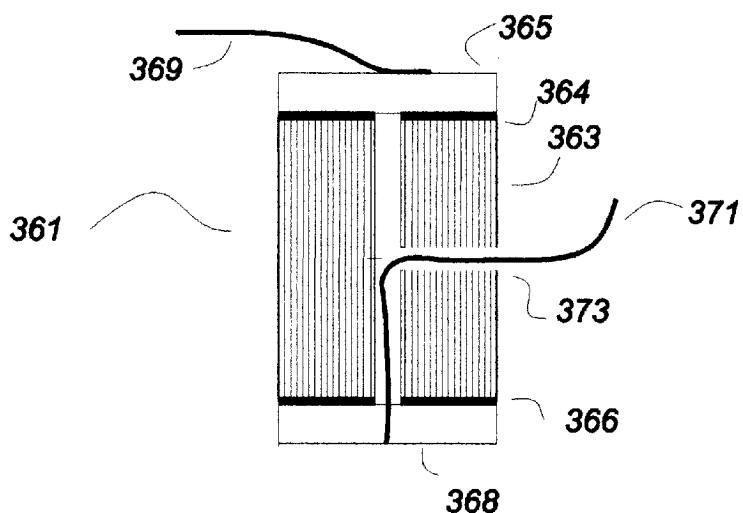


Fig. 17

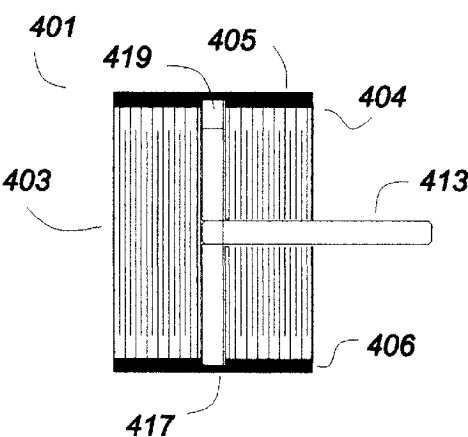


Fig. 18

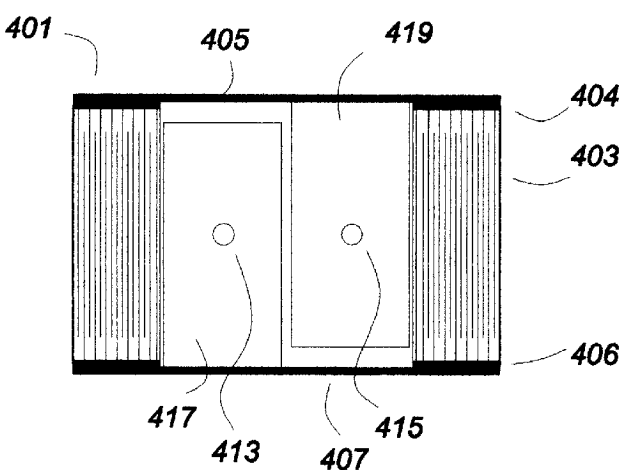


Fig. 19

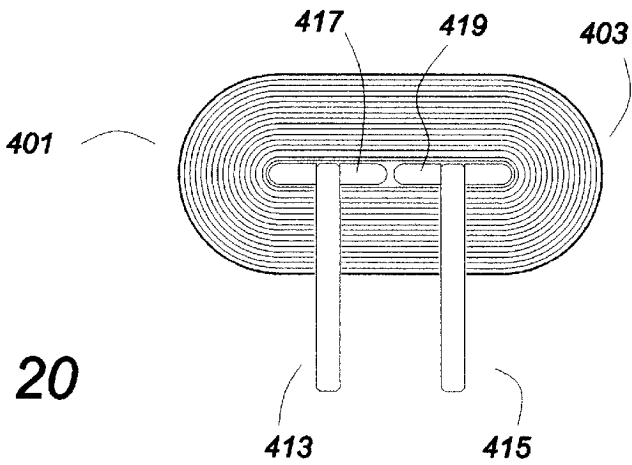


Fig. 20

### 3- AND 4-TERMINAL CAPACITORS WITH "FARADAY-SHIELDED" CONNECTIONS

This is a continuation in part application of a provisional application of the same name, Ser. No. 60/621,121, filed Jun. 27, 1996. Priority is claimed to that filing date.

#### BACKGROUND OF THE INVENTION

This invention relates to capacitors, and in particular 3- and 4-terminal capacitors.

Reference is made to a co-pending patent application "HIGH CURRENT, LOW INDUCTANCE CAPACITOR PACKAGES, Ser. No. 08/840424 filed Apr. 29, 1997; U.S. Pat. No. 5,659,455 "PACKAGING FOR ELECTRONIC CIRCUITS USING A CAPACITOR AS A STRUCTURAL MEMBER", issued Apr. 19, 1997; and to U.S. Pat. No. 4,916,576, "MATRIX CAPACITOR", filed Feb. 27, 1989 and issued Apr. 10, 1990.

3- and 4-terminal capacitors are sometimes used to reduce the effects of "lead inductance" in a capacitor. As an example, not a limitation, they may be used in low-pass filtering applications, such as the input and output filter capacitors in switched mode power supplies. A feed-through capacitor can be considered to be a kind of a 3-terminal capacitor.

#### BRIEF DESCRIPTION OF THE INVENTION

A pair of wires conducting an electrical current from a power source which were terminated on the inside of an ideal Faraday shield will be short circuited, and a pair of leads connected anywhere on the exterior of the ideal Faraday shield will detect no potential at DC (direct current) or any AC (alternating current) frequency from the power source. For a less than ideal Faraday shield, the potential on the exterior of the Faraday shield will be small, and can be determined by the current flow and the impedance, using network analysis, as in well known in the art of electrical engineering. At high frequency, the potential on the exterior of a Faraday shield made of a continuous conductor such as copper sheet metal will be further attenuated because AC currents tend not to penetrate a conductor, and thus will tend not to penetrate from the inside to the outside (or from the outside to the inside).

As taught in the copending patent application "PACKAGING FOR ELECTRONIC CIRCUITS USING A CAPACITOR AS A STRUCTURAL MEMBER" referenced above, a package comprising a top metal plate and a bottom metal plate and side walls which are a capacitor is a Faraday shield for AC at frequencies sufficiently high that the capacitor has a low impedance. High frequency noise from an electronic circuit within the package will be significantly attenuated outside of the package.

This invention teaches that the same phenomenon can be used in the construction of a 3- or 4-terminal capacitor, by connecting one or two of the three or four leads to the terminations of the capacitor from inside the capacitor. The lead(s) can then pass through the side of the capacitor to enable connection to a circuit.

#### BRIEF DESCRIPTION OF THE FIGURES

FIG. 1 shows a four terminal capacitor in which two of the terminals are connected to the inside surfaces of the end caps.

FIG. 2 shows a three terminal capacitor in which one of the terminals is connected to the inside surface of one end cap.

FIG. 3 shows a four terminal capacitor having very heavy leads and terminations, for high currents.

FIG. 4 shows that a four terminal capacitor may comprise additional components for further attenuation of noise.

FIG. 5 shows that heavy, overlapped but insulated conductors may be used, to enhance shielding and/or improve heat transfer, and coaxial termination.

FIG. 6 shows a three terminal capacitor in which the third terminal is connected to the inside surface of a first end cap. The second end cap encloses a conduit through which the third terminal can pass, so that capacitor types which are not easily drilled through may be used. FIG. 6 also shows concentric capacitor elements and that a feed through capacitor can be used to increase the attenuation at high frequencies.

FIG. 7 shows a five terminal capacitor, essentially comprising a pair of three terminal capacitors connected together in series.

FIG. 8 shows a wound four terminal capacitor in which the third and fourth terminals are connected to the end caps through holes drilled on a diagonal.

FIGS. 9 and 10 show a section and a bottom view of another embodiment of this invention using a stacked film capacitor body.

FIGS. 11 and 12 show a end and a bottom view of another embodiment of this invention using a stacked film capacitor body.

FIGS. 13 and 14 show a end and a bottom view of another embodiment of this invention using a pair of stacked film capacitor bodies.

FIGS. 15 and 16 show a side and top view of another embodiment of this invention using a stacked film capacitor body having heavy foil terminations for high current.

FIG. 17 shows a degenerate capacitor, having only one electrode with heavy metal end caps on both ends, nominally common because of the one electrode connects both. The degenerate capacitor has two (or more) terminations. In its most basic form, one termination is on the outside one is on the inside through a hole in the capacitor element.

FIGS. 18, 19 and 20 show that the capacitor element can be flattened to an oval, with broad flat studs inside connecting through holes in the capacitor element to heavy studs. This can be a two terminal capacitor, internally connected, or it can be a four terminal capacitor if connections are made to the metal end caps on the outside as well.

#### PREFERRED EMBODIMENT OF THE INVENTION

As additional background in understanding this invention, one must understand the "Faraday shield" and the concept of "penetration depth" as it relates to high frequency AC. Also, one should have some knowledge of the construction of capacitors, particularly metalized film capacitors.

The ideal "Faraday shield" comprises a perfectly conductive enclosure defining an interior space. No electric fields can penetrate into or penetrate out of the Faraday shield, since, as it is a perfect conductor, there can be no voltage gradients on its exterior or interior surface.

If one were to construct a metal sphere and put a power source inside it with electrical connections to diametrically opposite points, ideally no electric potential can exist between the points. In practice, there will be some finite impedance in the sphere, so some potential difference will exist, and this potential difference can be calculated as the

current flowing times the impedance. For a DC or low frequency AC, the same potential difference would be present at the corresponding points on the exterior of the sphere.

The above referenced patent application "PACKAGING FOR ELECTRONIC CIRCUITS USING A CAPACITOR AS A STRUCTURAL MEMBER" teaches that a band around a Faraday shield can be replaced with a capacitor. Specifically, an enclosure is disclosed comprising a top conductive plate, a bottom conductive plate, and side walls which comprise a capacitor. An ideal capacitor has an infinite impedance at DC and has zero impedance at an infinite frequency AC. Thus an AC Faraday shield can be constructed which can pass a DC current between its interior and exterior with no short circuit DC flowing through the capacitor in the AC Faraday shield. However, high frequency AC will be effectively short circuited by the capacitor.

As further background, a high frequency AC tends to flow on the surface of a conductor, and has a "penetration depth" into the surface of a conductor, as is well known to one skilled in the art. This penetration depth is an exact number, which can be calculated using well known equations, given the frequency of the AC and the properties of the conductor. The "penetration depth" terminology can be misleading unless one understands its definition and application. With respect to a wire conductor which is carrying a high frequency AC, the high frequency AC tends to flow near the surface of the conductor, so the conductor has a higher "apparent resistance" than the same conductor carrying a DC or low frequency AC. The "penetration depth" is a conceptual factor, being the wall thickness of a tube of the same outside diameter as the wire which has a DC conductivity corresponding to the apparent resistance.

It is sometimes believed, mistakenly, that AC current flows very well on the surface to the depth of the "penetration depth", and does not flow at all at deeper depths. In actuality, the penetration of the high frequency AC into a thick conductor is much greater than the "penetration depth", but AC is increasingly attenuated and also has an increasing phase difference as the distance from the surface increases. At some point below the surface of the conductor, the AC will have a 180 degree phase shift, and so will flow in the opposite direction, significantly attenuated. In a homogeneous conductor, the magnitude of the current density decreases below the surface as a log function.

If a wire conductor of an AC passed through the center of a metal disk having a thickness large compared to the penetration depth, the AC does not flow through the disk, but rather most of the AC will flow outward along its surface, around the edge, then back along the other surface to the wire again. If two such disks were connected by a closed metal tube having a thickness large compared to the penetration depth, so as to comprise an enclosure, very little AC will flow on the inside of the tube or on the enclosed surfaces of the disks. Also, a wire connecting the centers of the enclosed surfaces of the disks will carry very little AC.

(In this specification and the claims, the term "having a thickness that is large compared to the penetration depth" means a thickness sufficient to provide the degree of attenuation of the AC that is needed for a particular application. If it is required that very little AC penetrate, then the thickness might be several times the penetration depth as determined by the commonly used formula and definition. On the other hand, if only a small attenuation is sufficient for the application, the thickness might be less than the penetration

depth as determined by the commonly used formula and definition, it being related to the needs of the application rather than any other standard or definition.)

On the other hand, a DC will penetrate the disks quite readily, and current flow will divide between the outside tube and the inside wire in proportion to their DC resistance.

Finally, consider that the outside tube may be cut around, blocking DC and low frequency AC, and a capacitor element may be fitted to restore the circuit for high frequency AC. No DC currents can flow through the tube, and very little high frequency AC will flow through the interior wire.

As background, a metalized film capacitor comprises insulating films which have been "metalized", that is upon which a thin metal layer has been deposited. The metal may be selectively deposited or selectively removed so that there is an insulating margin on one or the other edge of a long strip of metalized film. When wound or stacked having the insulating margins on alternate ends, the ends can be metal sprayed, each end making contact with half of the metalized film alternately, so as to comprise a capacitor, as is well known to one skilled in the art.

Metalized film capacitors have the property that they can "heal", that is, if the alternating metalized layers should short circuit, as through a pin hole or the like, an electric current can be used to "clear" the short. In making stacked film capacitors, the capacitors are often made in long lengths, then they are sawed to short lengths, the length being one determinant of the value of the finished capacitor. The process of sawing the capacitor creates many localized short circuits, and these are cleared with electrical energy to make a capacitor with good electrical integrity and reliability. This is a routine manufacturing process, as would be known to one skilled in the art.

Similarly, a metalized film capacitor can be drilled through, and the resulting localized short circuits can be cleared. This can provide access to the interior of the capacitor.

With the above as background, FIG. 1 shows a four terminal capacitor 1 in section. A capacitor element 3 may be a tubular coil wound of metalized film upon a mandrel 8, a very common construction for capacitors. The layers of the capacitor element are extremely thin, too thin to draw, so they are represented diagrammatically. The alternating layers (electrodes) of the capacitor element 3 may connect respectively to metallized ends 4 and 6. This is a common construction for capacitors, as would be known by one skilled in the art.

The capacitor 1 further comprises metal ends 5 and 7, which could be, as an illustration, not a limitation, copper disks, copper caps or the like, or perhaps a particularly heavy metallization. The capacitor 1 may have wire terminals 9 and 11 bonded to the metal ends 5 and 7, which closely resembles conventional capacitor construction.

The capacitor element 3 has been drilled through so as to provide access for two additional wire terminals 13 and 14 which are bonded to the inside surface of the metal ends 5 and 7.

Usually, in the construction of tubular metalized film capacitors, the film is wound with some minimal wasted space in the middle left when the mandrel upon which it is wound is removed. The ends may be metal sprayed, and a small hole may be left in the center. The capacitor 1 of FIG. 1 must have sufficient space left in the center of the capacitor element 3 so that the hole can be drilled through the side of the capacitor element 3 and the wire terminals 13 and 14 can be threaded through. It is preferred (but it is not necessary)

that a tubular mandrel **8** be used and that it be left in place. When the hole is drilled through the capacitor element **3**, any resulting short circuits must be cleared. The edges of the hole may be protected and stabilized in some manner, for example and not as a limitation, by coating with a sealant or bonding in an insulating sleeve. Alternatively, the wire terminals **13** and **14** may be of insulated wire, and a dab of sealant could simultaneously protect and stabilize the hole, locate the wire terminals **13** and **14** in place and seal the capacitor **1**.

The wire terminals **13** and **14** may be attached to the metal ends **5** and **7** before the metal ends **5** and **7** are fixed to the ends of the capacitor element **3**. The metal ends **5** and **7** are preferably thick compared to the penetration depth for any high frequency AC which it is to be attenuated, and it is preferred that they cover the entire end of the capacitor **1**. At a minimum, any holes should be covered.

Consider, as an illustration, not a limitation, that the capacitor **1** of FIG. **1** may be used in a filter network for a switched mode power converter. One side of the power circuit might comprise wire terminals **9** and **13**, while the return side might comprise wire terminals **14** and **11**. For a DC, wire terminal **9** is directly connected to wire terminal **13** through the metal end cap **5**. Similarly wire terminal **14** is directly connected to wire terminal **11** through the metal end cap **7**.

Consider further that there may be a high frequency AC noise source connected to wire terminals **9** and **11**. This is a common occurrence in a switched mode power supply, and capacitors are often used to attenuate the high frequency AC noise. Very little of the high frequency AC can penetrate the metal end caps **5** and **7**, so the AC will flow across the surface of the metal end caps **5** and **7**. In the absence of the capacitor element **3**, the currents would then flow back along the other side of the end caps to the wire terminals **13** and **15**. However, the capacitor element **3** provides a short circuit path for high frequency AC between the wire terminals **9** and **11**.

Further, the flow of high frequency AC is blocked from flowing along the inside surface of metal end caps **3** and **7** by a plurality of metal layers, comprising the metallized surfaces of the metallized film of which the capacitor element **3** is constructed. As the high frequency AC tries to flow from the outside to the center of the metal end caps **5** and **7**, it will encounter a succession of metal surfaces. These metal surfaces are extremely thin, so the AC can penetrate any one of them substantially, but with some attenuation at each. Because there are a very large number of layers, the cumulative effect is that the high frequency AC will be significantly attenuated. Thus not only does the capacitor element **3** provide a short circuit between the metal end caps **5** and **7** for high frequency AC, but it also provides an effective barrier to high frequency AC between wire terminals **1** and **13** and between wire terminals **14** and **11**.

This effect will be enhanced if the capacitor element **3** is relatively thick from its inside diameter to its outside diameter, and relatively short, from end to end.

The capacitor **1** of FIG. **1** has utility as a two terminal capacitor as well. When terminated only by the internal leads **13** and **14**, the capacitor **1** is a superior two terminal capacitor having low "lead" inductance. A two terminal configuration using one internal lead **13** or **14** and one external lead **11** or **9** has unique characteristics which may be useful in some circuits. If the connections are to opposite ends, one internal and one external, DC is blocked and high frequency AC is attenuated. If the connections are to the

same end, one external and one internal, DC is conducted well but high frequency AC is attenuated.

FIG. **2** shows a three terminal capacitor **21** which is similar in many ways to the capacitor **1** of FIG. **1**. A capacitor element **23** has metal end caps **25** and **27** to which wire terminals **29** and **31** are bonded on the outside. A third wire terminal **33** is bonded to the inside surface of metal end cap **25**. High frequency AC flow from wire terminal **29** to wire terminal **33** will be significantly attenuated. As an example, if a high frequency AC noise source is connected to wire terminals **29** and **31**, the high frequency AC noise will be significantly attenuated at a load connected to wire terminals **33** and **31**, but DC can flow unimpeded.

The capacitor **41** of FIG. **3** is constructed to carry large DC. A capacitor element **43** is connected to metal end caps **45** and **47**. Large terminals **49** and **51** are bonded to the outside surfaces of the metal end caps **45** and **47**. Heavy metal studs **57** and **59** are bonded to the inside surfaces of the metal end caps **45** and **47**. Heavy wire terminals **53** and **55** are connect to the heavy metal studs through holes drilled in the capacitor element **43**.

End cap assemblies may be made ahead of time, comprising, for example, the metal end cap **45**, the large terminal **49** and the heavy metal stud **57**, pre-drilled to accept a heavy wire terminal **53**. A pair of these assemblies can be inserted into the ends of the capacitor element **43**, and bonded to the respective metallized ends of the capacitor element **43**, as by soldering, as an illustration, not a limitation. The heavy wire terminals **53** and **55** can be installed through holes in the capacitor element **43**. The heavy wire terminals **53** and **55** can be attached to the heavy metal studs **57** and **59** in any of several ways, for example but not as a limitation, by press fit, by machine thread, or by reflow soldering or a combination thereof. It is also possible that the heavy wire terminals **53** and **55** would not be part of the capacitor **41** as it was made. There could be only the through holes in the capacitor element **43** and holes in the heavy metal studs **57** and **59**, to later receive the heavy metal terminals **53** and **55** as plugged in terminals when the capacitor **41** is installed in an assembly.

FIG. **4** shows that a capacitor **71** may comprise additional components to further attenuate high frequency AC noise or to damp resonant oscillations. A capacitor element **73** has metal end caps **75** and **77**. Wire terminals **79** and **81** are bonded to the metal end caps **75** and **77**. Wire terminals **83** and **85** pass through a hole in the capacitor element **73** and are bonded to the inside surface of the end caps **75** and **77**.

Additional components may be installed to further attenuate high frequency AC noise, as an example for illustration and not as a limitation, a small high frequency capacitor **93** may be located and connected internally to the wires **83** and **85**. Differential mode filters **87** and **89**, and/or a common mode filter **91** could also be installed. All of the filters could be inside the capacitor element **73** or outside of it, or partly inside and partly outside, as shown. The common mode filter **91** could line the hole in the capacitor element **91** as a combined filter and sleeve, particularly if it were of an insulating material such as nickel-zinc-ferrite. The filters may be of sintered powdered iron or of ferrite, as examples, not as limitations. In addition, or alternatively, such additional components may be used to damp out resonant oscillations.

FIG. **5** shows that heavy metal inserts **117** and **119** may be added to a four terminal capacitor **101**. A capacitor element **103** has metal end caps **105** and **107**, with wire terminals **109** and **111** bonded thereto. Coaxial wire terminals **113** and **115**

pass through a hole in the capacitor element **103** and are bonded respectively to the heavy metal inserts **117** and **119**. The heavy metal inserts **117** and **119** are bonded respectively to the metal end caps **105** and **107**,

The heavy metal shields **117** and **119** overlap but are separated by a thin layer of electrical insulation, too thin to draw, and thus not illustrated, to prevent a short circuit for DC. Each is bonded to one of the end caps **105** and **107**. The thin overlapped but insulated joint is a capacitor itself, and will provide some additional attenuation for high frequency AC noise. The metal shields **117** and **119** are very good conductors, so heavy DC may be conducted without significant heating, and the metal shields **117** and **119** would be beneficial in conducting any such heat from the interior of the capacitor. They would also increase the strength of the finished assembly. As an alternate construction, they could be on the outside of the capacitor **101**.

The three terminal capacitor **131** of FIG. 6 has two concentric capacitor elements **133** and **134** in parallel. The internally connected wire terminal **143** need not pass through the capacitor elements **133** and **134**. While metalized film capacitors may be drilled and cleared of localized short circuits, with other types of capacitor construction this may be difficult or impossible. The capacitor elements **133** and **134** are concentric, and are bonded on one end to a metal end cap **135** to which a wire terminal **139** is bonded. They are bonded to a much more substantial second end cap **145** on the other end, with a wire terminal **141** bonded thereto. The second end cap has therein a conduit **137** through which a wire terminal **143** may pass so as to be connected to the inside surface of the end cap **135**.

FIG. 6 shows that the wire terminal **143** optionally can pass through a feed through capacitor **147** in the second end cap **145** to further attenuate high frequency AC noise.

Capacitors of different types are sometimes used in parallel to take advantage of differences in their characteristics to improve the whole. One element might be an extended foil capacitor paralleled with a second element which might be a metalized foil capacitor. Other types of capacitors might be used, and as illustrations, not limitations, they might not be concentric, or they could be of different lengths, the end caps having contours to accommodate any physical differences to make a good electrical connection.

FIG. 7 shows a five terminal capacitor **151**. A first capacitor element **153** has an end cap **155** having a wire terminal **159** bonded thereto. A second capacitor element **154** has an end cap **157** having a wire terminal **161** bonded thereto. The first and second capacitor elements **153** and **154** are bonded to a central metal connection **156** having a wire terminal **160** bonded thereto.

The central metal connection **156** further has two conduits therein so that wire terminals **163** and **165** can pass through and connect to the end caps **159** and **161**. Thus the capacitor **151** comprises two capacitor elements in series. If they have equal capacitance, such a construction would be useful in the familiar half-bridge circuit. As an example and not a limitation, a source of DC power could be connected to the wire terminals **163** and **165**. The connections to the half bridge circuit could be the wire terminals **159**, **160** and **161**. High frequency AC noise originating in the half bridge circuit would be substantially attenuated at the DC power source. As an illustration, not a limitation, the capacitor elements **153** and **154** could be of a construction which are less practical to be drilled through, such as wound foil.

A number of variations in this general construction would be possible the wires **163** and **165** could pass through holes

in one or the other or both of the capacitor elements **153** and **154**. In this were done, the metal connection **156** could be a thin metal ring, perhaps with a tab extending outward (and/or inward) for connection to the wire **160**. The wire **160** could be internally connected to the metal connection **156**, exiting with the wires **163** and **165** to make an alternative five terminal capacitor. More sections could be used, terminated in a variety of ways.

As shown in the capacitor **181** of FIG. 8, the threading of the terminal wires **193** and **195** through the capacitor element **183** to the end caps **185** and **187** may be simplified and more easily automated if the holes in the capacitor element **183** were drilled diagonally, straight through the end caps **185** and **187**. Further, the extra space left in the center of the capacitor element **183** could be very small, much smaller than shown, as the wires **193** and **195** do not need to be threaded through the center. Performance would not be greatly effected if the holes in the end caps **185** and **187** were somewhat off center.

Close inspection of FIG. 8 shows that the wire terminals **193** and **195** pass through holes in the metal end caps **185** and **187** and are bonded to the outside surfaces. This may be easier for assembly in some instances, and it is immaterial to which side of the metal end **185** and **187** the terminals **193** and **195** are physically bonded as long as any space around the wire terminals **193** and **195** in the metal end caps **185** and **187** is substantially filled with a good conductor, such as solder. This places the effective bond on the inside surface and the phrase "bonded to the inside surface" as used in this specification and the claims includes this construction as well as any other which accomplish a similar electrical result.

The wire terminals **189**, **191**, **193** and **195** may all be physically bonded to the outside of the end caps **185** and **187**. As long as solder substantially fills the hole around the wire terminals **193** and **195** in the end caps **185** and **187** the wire terminals **193** and **195** are effectively bonded to the inside surface of the end caps **185** and **187**. The capacitor **181** is well suited to printed circuit board use. A surface mount variant could be easily made by bending the wire terminals **193** and **195** back parallel to the capacitor element **183**. The wire terminals **189** and **191** would then not be needed, as the end caps **185** and **187** would be suitable for use as surface mount terminations.

In this embodiment, the end caps **185** and **187** are drawn cups, a construction which could be used alternatively in many of the embodiments shown.

FIGS. 9 and 10 show a capacitor **201** in end and bottom view respectively. The capacitor element **203** is a stacked metalized film capacitor having metalized ends **205** and **207**. Wire terminals **213**, **214**, **215** and **216** may pass through drilled holes and may be bonded to the metalized ends **205** and **207**. As long as solder fills any voids around the wire terminals **213**, **214**, **215** and **216** in the metalized ends **205** and **207**, the wire terminals **213**, **214**, **215** and **216** are effectively bonded to the inside surface of the metalized ends **205** and **207**. Wire terminals **209**, **210**, **211** and **212** are bonded to the outside of the metalized ends **205** and **207**. Although having eight leads, this is equivalent to a four terminal capacitor, the extra leads serving to increase the current carrying capacity of the capacitor **201** and distribute the current more evenly.

Although the capacitor **201** of FIGS. 9 and 10 does not have the multiple layers of continuous metalized film that the capacitors of FIGS. 1 through 8, there still is provided a substantial spacing filled with alternating capacitor layers

between the inside connection of the leads to the edge of the metalized ends, so much of the advantage of inside connection of the wound capacitors will be retained. High frequency AC does not readily penetrate the capacitor element even though it appears to have a path to follow along the metalized layers of the capacitor. For longer stacked film capacitors, any number of sets of wire terminals may be used for greater current capacity and to better distribute the current, as long as they are not too near the edge of the metalized ends.

Stacked metallized film capacitors typically have a fairly heavy metallization, often of aluminum and/or babbitt or the like. These metals have a lower conductivity than copper, so the penetration depth will be greater. If necessary, the metallization can be supplemented with a sheet of copper bonded to the surface thereof. The increased thickness and the lower conductivity of the surface will have relatively more AC attenuation through the material.

The capacitor **221** of FIGS. **11** and **12** is very similar to the capacitor **201** of FIGS. **9** and **10**, except that the leads **225** and **227** are drilled diagonally in the plane of the stacked foils.

The capacitor **229** of FIGS. **13** and **14** comprises two capacitor elements **221** and **222**, which are the same as the capacitor **221** of FIGS. **11** and **12**. This shows that the capacitors may be connected in series through connections **224** and **226**. The resulting capacitor **229** may be used as a four terminal capacitor having more attenuation. With easy access to all of the various terminations, the capacitor **229** could be used as a three terminal capacitor, a four terminal capacitor, a five terminal capacitor or a six terminal capacitor. With additional capacitor elements, a number of imaginative circuits and networks could be made.

FIGS. **15** and **16** show an alternate method of terminating a stacked film capacitor. The capacitor **231** comprises a capacitor element **233** having metal sprayed ends **235** and **237** having large "L" shaped terminals **239** and **341** bonded respectively thereto for carrying high currents. Heavy metal foil terminals **243** and **245** connect to the inside surface of the metal sprayed ends **235** and **237**. In practice, stacked film capacitors are often made with a plurality of thinner stacked sections, one placed atop another until the desired total number of layers is achieved for the capacitance value needed. The foil terminals **243** and **245** may be placed between such intermediate sections. Additional similar sets of foil terminals may be used to increase the current capacity of the capacitor. Then when the ends are metal sprayed, connection to the heavy metal foil terminals will be made as well. Care should be taken to be sure that the heavy metal foils are exposed on the surface of the ends of the capacitor when the ends are metal sprayed.

For surface mounting to a circuit board with minimum inductance, the foil terminals **243** and **245** may have multiple alternating surface mounting pads **243a**, **245a**, **243b** and **245b**. Obviously, a number of alternative mounting and terminating schemes could be used, as would be apparent to one skilled in the art.

In making a capacitor in the style of FIGS. **15** and **16**, the foil terminals **243** and **245** may be immediately adjacent to each other (it being understood that they must be insulated), or there may be one or more intermediate sections of the capacitor element between them. The electrical characteristics will be somewhat different, and one or the other may be preferred in different applications.

FIG. **17** shows a "degenerate" capacitor **361**. A "capacitor element" **363** comprises a coil of metallized film, as an

example not a limitation, or a coil of foil interleaved with film. The "capacitor element" **361** has metallization **364** and **366** on its respective two ends to which heavy metal end caps **365** and **368** respectively have been bonded. An external lead **369** bonds to one end cap **365** on its outside surface. An internal lead **371** bond to the other end cap **368** on its inside surface and exits the "capacitor" through a hole **373** in the side wall of the capacitor **361**. This device passes a DC, and high frequency AC is delayed and attenuated.

FIGS. **18**, **19** and **20** show section views from three sides of a capacitor **403** in which the capacitor element **403** is an oval. Frequently, film capacitors are made in an oval shape, often by winding a round capacitor element with ample space in the center, then flattening it by lateral pressure. Two heavy metallized end caps **405** and **407** are bonded respectively to heavy flat metal studs **419** and **417** and to the metallized ends **404** and **406** of the capacitor element **403**. Heavy metal terminals **413** and **415** are bonded to the heavy metal studs **417** and **419** respectively and exit the capacitor **401** through holes in the capacitor element **403**.

This capacitor **401** may be used as a two terminal internally connected capacitor. Alternatively, it may be used as a four terminal capacitor in additional connections to an external circuit are made to the heavy metal end caps **405** and **407**.

In this specification and the claims, the term "tubular" includes oval shapes and other many other shapes, it being recognized that "tubes" come in a variety of geometries, including but not limited to round, oval, square, hexagonal, octagonal, etc., and "tubular" would even encompass fabricated tubes, for example, not as a limitation, a square tube fabricated of four stacked film capacitors with mitered or butt joints as corners.

One skilled in the art of capacitors will readily understand that the teachings of this invention may be applied to a wide variety of capacitors for a wide variety of applications. As an illustration, not a limitation, some electrolytic capacitors are made of wound foil or sintered metal. Some multiple layer ceramic capacitors are stacked film, others are rolled. Given the several examples illustrated above, it is apparent that the teachings of this invention can be used with such capacitor elements of other design, materials and construction if they are fabricated in, or assembled into an appropriate shape and are terminated according to the teachings of this invention.

I claim:

1. A capacitor comprising

a capacitor element having a first electrode terminated on a first metal end cap and a second electrode terminated on a second metal end cap

the capacitor element and the first and second metal end caps enclosing an axial cavity

the capacitor element further having at least a first hole through the capacitor element from the axial cavity out of the capacitor;

a first termination for connecting to an external circuit bonded to the first metal end cap outside of the first metal end cap

a second termination for connecting to the external circuit bonded to the second metal end cap outside of the second metal end cap and

a third termination for connecting to the external circuit bonded to the first metal end cap within the first metal end cap and passing out of the capacitor through the axial cavity and the at least a first hole.

2. The capacitor of claim 1 wherein

## 11

the capacitor is a capacitor for attenuating a high frequency alternating voltage

and the first metal end cap and the second metal end cap each have a thickness which is large compared to a penetration depth of the high frequency alternating voltage.

**3. A capacitor comprising**

a capacitor element having a first electrode terminated on a first metal end cap and a second electrode terminated on a second metal end cap

the capacitor element and the first and second metal end caps enclosing an axial cavity

the capacitor element further having at least a first hole through the capacitor element from the axial cavity out of the capacitor;

a first termination for connecting to an external circuit bonded to the first metal end cap outside of the first metal end cap

a second termination for connecting to the external circuit bonded to the second metal end cap outside of the second metal end cap,

a third termination for connecting to the external circuit bonded to the first metal end cap within the first metal end cap and passing out of the capacitor through the axial cavity and the at least a first hole, and

a fourth termination for connecting to the external circuit bonded to the second metal end cap within the second metal end cap and passing out of the capacitor through the axial cavity and the at least a first hole.

**4. The capacitor of claim 3 wherein**

the capacitor is a capacitor for attenuating a high frequency alternating voltage and the first metal end cap and the second metal end cap each have a thickness which is large compared to a penetration depth of the high frequency alternating voltage.

**5. A capacitor comprising**

a first capacitor element having a first electrode terminated on a first metal end cap and a second electrode terminated on a metal connector

a second capacitor element having a first electrode terminated on the metal connector and a second electrode terminated on a second metal end cap

the first capacitor element, the second capacitor element the metal connector and the first and second end caps enclosing an axial cavity

the capacitor further having at least a first hole through at least one of the first capacitor element, the second capacitor element and the metal connector from the axial cavity going out of the capacitor

a first termination for connecting to an external circuit bonded to the first metal end cap outside the first metal end cap

a second termination for connecting to the external circuit bonded to the second metal end cap outside the second metal end cap

a third termination for connecting to the external circuit bonded to the first metal end cap inside the first metal end cap and passing out of the capacitor through the axial cavity and the at least a first hole, and

a fourth termination for connecting to the external circuit bonded to the second metal end cap inside the second metal end cap and passing out of the capacitor through the axial cavity and the at least a first hole.

**6. The capacitor of claim 5 further comprising a fifth termination for connecting to the external circuit bonded to the metal connector outside the metal connector.**

## 12

**7. The capacitor of claim 5 further comprising**

a fifth termination for connecting to the external circuit bonded to the metal connector within the metal connector and passing out of the capacitor through the axial cavity and the at least a first hole through the capacitor element.

**8. The capacitor of claim 5 wherein**

the capacitor is a capacitor for attenuating a high frequency alternating voltage and the first metal end cap; the second metal end cap and the metal connector each have a thickness which is large compared to a penetration depth of the high frequency alternating voltage.

**9. A capacitor comprising**

at least a first capacitor element having a first electrode terminated on a first metal end cap and a second electrode terminated on a second metal end cap the at least a first capacitor element further having at least a first hole through the at least a first capacitor element going out of the capacitor;

a first termination for connecting to an external circuit bonded to the first metal end cap within the first metal end cap and passing out of the capacitor through the at least a first hole through the capacitor element, and

a second termination for connecting to the external circuit bonded to the second metal end cap within the second metal end cap and passing out of the capacitor through the at least a first hole through the capacitor element.

**10. The capacitor of claim 9 as a four terminal capacitor wherein the capacitor element is at least one of a tubular capacitor element and a stacked film capacitor element and further comprising**

a third termination for connecting to the external circuit bonded to the first metal end cap outside the first metal end cap, and

a fourth termination for connecting to the external circuit bonded to the second metal end cap outside the second metal end cap.

**11. The capacitor of claim 9 wherein**

the capacitor is a capacitor for attenuating a high frequency alternating voltage and the first metal end cap and the second metal end cap each have a thickness which is large compared to a penetration depth of the high frequency alternating voltage.

**12. A capacitor comprising**

at least a first capacitor element having a first electrode terminated on a first metal end cap and a second electrode terminated on a second metal end cap the at least a first capacitor element further having at least one hole through the capacitor element going out of the capacitor;

a first termination for connecting to an external circuit bonded to at least one of the first metal end cap and the second metal end cap outside of the at least one of the first metal end cap and the second metal end cap, and

a second termination for connecting to the external circuit bonded to at least one of the first metal end cap and the second metal end cap within the at least one of the first metal end cap and the second metal end cap and passing out of the capacitor through the at least one hole through the capacitor element.

**13. The capacitor of claim 12 wherein**

the capacitor is a capacitor for attenuating a high frequency alternating voltage and the first metal end cap and the second metal end cap each have a thickness which is large compared to a penetration depth of the high frequency alternating voltage.